TOSHIBA TLRH160

TOSHIBA LED LAMP InGaA&P RED LIGHT EMISSION

TLRH160

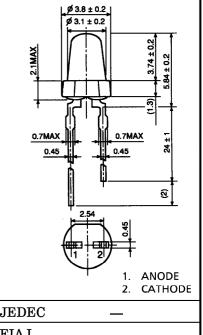
PANEL CIRCUIT INDICATOR

- 3.1 mm DIAMETER (T1)
- InGaA&P RED LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Red Light Emission Recommended Forward Current : $I_F = 1 \sim 20 \text{ mA}$ (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- APPLICATIONS: Suitable for Outdoor Message Signboard, Safety equipment, etc..

MAXIMUM RATINGS (Ta = 25°C)

SYMBOL	RATING	UNIT
${ m I_F}$	50	mA
$v_{ m R}$	4	V
$P_{\mathbf{D}}$	125	mW
${ m T_{opr}}$	-30~85	°C
$\mathrm{T_{stg}}$	-40~120	°C
	$I_{\mathbf{F}}$ $V_{\mathbf{R}}$ $P_{\mathbf{D}}$ T_{opr}	$\begin{array}{c cccc} I_{F} & 50 \\ V_{R} & 4 \\ P_{D} & 125 \\ T_{opr} & -30{\sim}85 \\ \end{array}$

Unit in mm



JEDEC EIAJ TOSHIBA 4-3E1A

Weight: 0.14 g

ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta = 25°C)

CHAR	ACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Forward Vo	ltage	$ m V_{f F}$	$I_{ m F}=20~{ m mA}$	_	1.9	2.5	V
Reverse Cu	rrent	${ m I}_{ m R}$	$V_{R} = 4 V$	_	_	50	μ A
Luminous	TLRH160	I _V	I_V $I_F = 20 \text{ mA (Note)}$	850	1800	_	mcd
Intensity	TLRH160 (ST)			850	_	4140	
Peak Emiss	ion Wavelength	$\lambda_{\mathbf{p}}$	$I_{ m F}=20~{ m mA}$	_	644	_	nm
Spectral Line Half Width		Δλ	$I_{ m F}=20~{ m mA}$		18	_	nm
Dominant V	Vavelength	$^{\lambda}{ m d}$	$I_{ m F}=20{ m mA}$	_	630	_	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity. Measurement tolerance for each limit is $\pm 15\%$.

S: 1000-2000 mcd, T: 1800-3600 mcd, U: 3200-6400 mcd.

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 Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

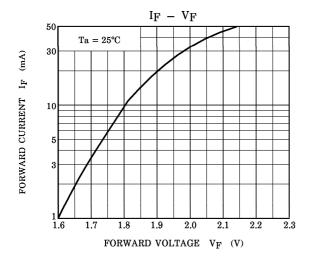
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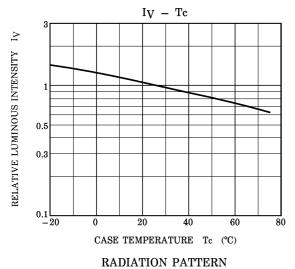
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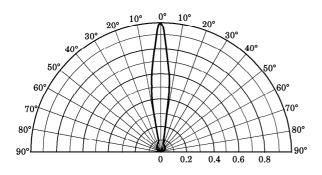
PRECAUTION

Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.







 $Ta = 25^{\circ}C$

